

FS7SM-18-VB Datasheet N-Channel 900V (D-S) Super Junction Power MOSFET

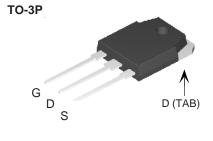
PRODUCT SUMMAI	RY	900	
V _{DS} (V) at T _J max.	900	900	
R _{DS(on)} at 25 °C (Ω)	$V_{GS} = 10 V$ 0.		
Q _g max. (nC)	20		
Q _{gs} (nC)	2.4		
Q _{gd} (nC)	11		
Configuration	Single		

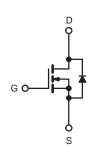
FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Qq)
- Avalanche energy rated (UIS)

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial





N-Channel MOSFET

PARAMETER			SYMBOL	LIMIT	UNIT		
Drain-Source Voltage			V _{DS}	900	V		
Gate-Source Voltage			V _{GS}	± 30	7 v		
Continuous Drain Current (T _J = 150 °C)	V at 10 V	V_{GS} at 10 V $T_{C} = 25 ^{\circ}\text{C}$ $T_{C} = 100 ^{\circ}\text{C}$	- I _D	9	А		
	V _{GS} at 10 V			7.3			
Pulsed Drain Current ^a			I _{DM}	28	1		
Linear Derating Factor				1.89	W/°C		
Single Pulse Avalanche Energy b Maximum Power Dissipation Operating Junction and Storage Temperature Range			E _{AS}	86	mJ		
			P _D	109	W		
			T _J , T _{stg}	-55 to +150	°C		
Drain-Source Voltage Slope	$T_{J} = 1$	25 °C		50	1//20		
Reverse Diode dV/dt ^d			dV/dt -	3.2	- V/ns		
Soldering Recommendations (Peak Temperature) c	for	10 s		300	°C		

- a. Repetitive rating; pulse width limited by maximum junction temperature. b. $V_{DD}=50$ V, starting $T_J=25$ °C, L=28.2 mH, $R_g=25$ Ω , $I_{AS}=3.5$ A.

- c. 1.6 mm from case. d. $I_{SD} \le I_D$, dl/dt = 100 A/ μ s, starting $T_J = 25$ °C.

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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	72	°C/W	
Maximum Junction-to-Case (Drain)	R _{thJC}	-	0.7	G/ VV	

PARAMETER	SYMBOL	OL TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		<u> </u>					•
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		900	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, I _D = 1 mA		-	0.65	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$		2	-	4	V
		$V_{GS} = \pm 20 \text{ V}$ $V_{GS} = \pm 30 \text{ V}$		-	-	± 100	nA
Gate-Source Leakage	I _{GSS}			-	-	± 1	μA
		V _{DS} = 900 V, V _{GS} = 0 V V _{DS} =620 V, V _{GS} = 0 V, T _J = 125 °C		-	-	1	μΑ
Zero Gate Voltage Drain Current	I_{DSS}			-	-	10	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 6 A	-	0.75	-	Ω
Forward Transconductance	9 _{fs}	V _{DS} = 30 V, I _D = 6 A		-	19	-	S
Dynamic							
Input Capacitance	C _{iss}	$V_{GS} = 0 \text{ V}, \\ V_{DS} = 100 \text{ V},$		_	373	T -	
Output Capacitance	C _{oss}			-	26	-	
Reverse Transfer Capacitance	C _{rss}	1	f = 1 MHz	-	14	-	
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	V _{DS} = 0 V to 520 V, V _{GS} = 0 V		-	46	-	pF
Effective Output Capacitance, Time Related ^b	C _{o(tr)}			-	64	-	
Total Gate Charge	Qg			-	26		
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 6 \text{ A}, V_{DS} = 520 \text{ V}$	-	2.1	-	nC
Gate-Drain Charge	Q _{gd}	1		-	2.8	-	
Turn-On Delay Time	t _{d(on)}	$V_{DD} = 620 \text{ V}, I_{D} = 6 \text{ A},$ $V_{GS} = 10 \text{ V}, R_{g} = 9.1 \Omega$ $f = 1 \text{ MHz, open drain}$		-	26	-	ns
Rise Time	t _r			-	55.7	-	
Turn-Off Delay Time	t _{d(off)}			-	71	-	
Fall Time	t _f			-	41	-	
Gate Input Resistance	R_{g}			-	3.5	-	Ω
Drain-Source Body Diode Characteristic	S						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode T _J = 25 °C, I _S = 6 A, V _{GS} = 0 V		-	-	7	
Pulsed Diode Forward Current	I _{SM}			-	-	18	_ A
Diode Forward Voltage	V _{SD}			-	-	1.4	V
Reverse Recovery Time	t _{rr}	T _J = 25 °C, I _F = I _S = 6 A, dl/dt = 100 A/μs, V _R = 400 V		-	192	-	ns
Reverse Recovery Charge	Q _{rr}			_	2.4	-	μC
Reverse Recovery Current	I _{RRM}			_	11		A

Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} . b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

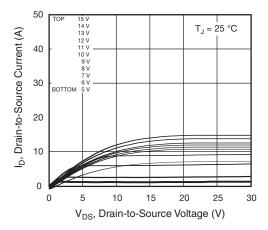


Fig. 1 - Typical Output Characteristics

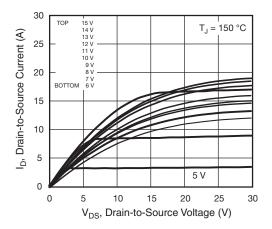


Fig. 2 - Typical Output Characteristics

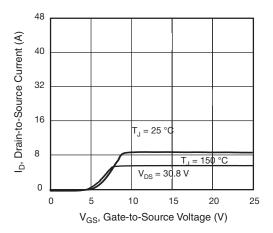


Fig. 3 - Typical Transfer Characteristics

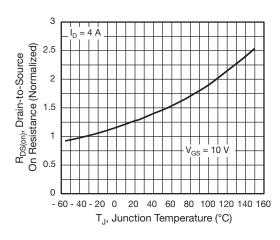


Fig. 4 - Normalized On-Resistance vs. Temperature

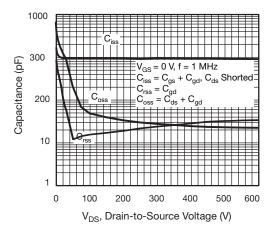


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

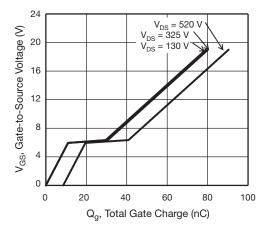


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



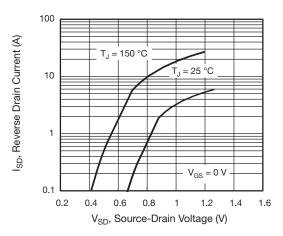


Fig. 7 - Typical Source-Drain Diode Forward Voltage

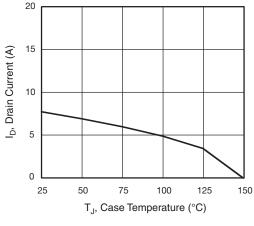


Fig. 9 - Maximum Drain Current vs. Case Temperature

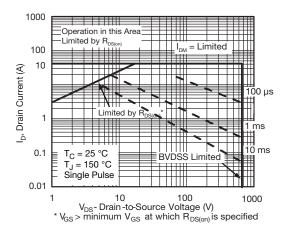


Fig. 8 - Maximum Safe Operating Area

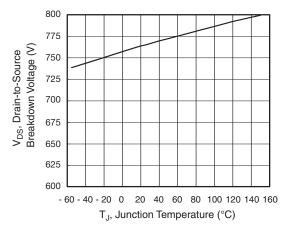


Fig. 10 - Temperature vs. Drain-to-Source Voltage

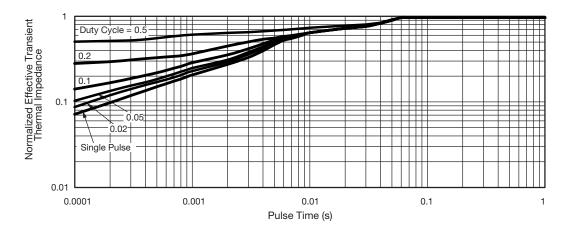


Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case

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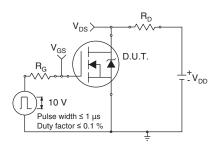


Fig. 12 - Switching Time Test Circuit

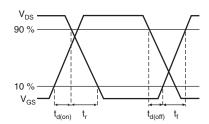


Fig. 13 - Switching Time Waveforms

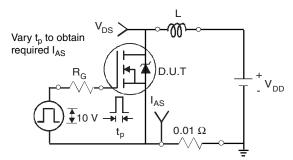


Fig. 14 - Unclamped Inductive Test Circuit

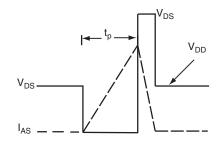


Fig. 15 - Unclamped Inductive Waveforms

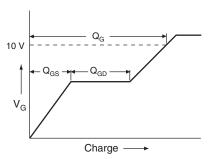


Fig. 16 - Basic Gate Charge Waveform

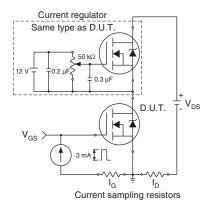
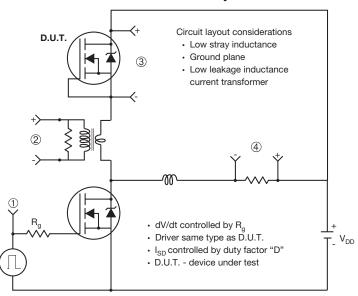


Fig. 17 - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit



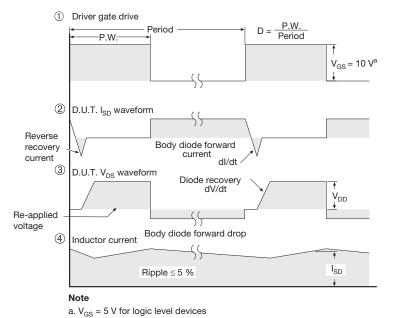


Fig. 18 - For N-Channel



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